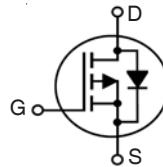


PolarP™
Power MOSFET

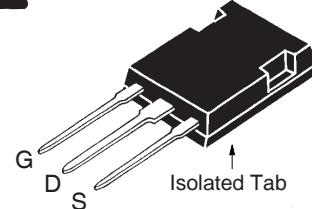
IXTR90P10P

P-Channel Enhancement Mode
Avalanche Rated



V_{DSS} = - 100V
I_{D25} = - 57A
R_{DS(on)} ≤ 27mΩ

ISOPLUS247
E153432



G = Gate D = Drain
S = Source

Symbol	Test Conditions	Maximum Ratings		
V_{DSS}	T _J = 25°C to 150°C	- 100	V	
V_{DGR}	T _J = 25°C to 150°C, R _{GS} = 1MΩ	- 100	V	
V_{GSS}	Continuous	±20	V	
V_{GSM}	Transient	±30	V	
I_{D25}	T _C = 25°C	- 57	A	
I_{DM}	T _C = 25°C, Pulse Width Limited by T _{JM}	- 225	A	
I_A	T _C = 25°C	- 90	A	
E_{AS}	T _C = 25°C	2.5	J	
dv/dt	I _S ≤ I _{DM} , V _{DD} ≤ V _{DSS} , T _J ≤ 150°C	10	V/ns	
P_D	T _C = 25°C	190	W	
T_J		-55 ... +150	°C	
T_{JM}		150	°C	
T_{stg}		-55 ... +150	°C	
T_L	1.6mm (0.062 in.) from Case for 10s	300	°C	
T_{sold}	Plastic Body for 10s	260	°C	
V_{ISOL}	50/60 H _z , RMS t = 1min	2500	V~	
M_d	Mounting Force	20..120/4.5..27	N/lb.	
Weight		6	g	

Symbol	Test Conditions (T _J = 25°C, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
BV_{DSS}	V _{GS} = 0V, I _D = - 250μA	-100		V
V_{GS(th)}	V _{DS} = V _{GS} , I _D = - 250μA	- 2.0		- 4.0 V
I_{GSS}	V _{GS} = ±20V, V _{DS} = 0V			±100 nA
I_{DSS}	V _{DS} = V _{DSS} , V _{GS} = 0V T _J = 125°C			- 25 μA - 200 μA
R_{DS(on)}	V _{GS} = -10V, I _D = - 45A, Note 1			27 mΩ

Features

- Silicon Chip on Direct-Copper Bond (DCB) Substrate
 - UL Recognized Package
 - Isolated Mounting Surface
 - 2500V~ Electrical Isolation
- Avalanche Rated
- High Current Handling Capability
- Fast Intrinsic Diode
- The Rugged PolarP™ Process
- Low Q_G
- Low Drain-to-Tab capacitance
- Low Package Inductance

Advantages

- Easy to Mount
- Space Savings
- High Power Density

Applications

- High-Side Switches
- Push Pull Amplifiers
- DC Choppers
- Automatic Test Equipment
- Current Regulators

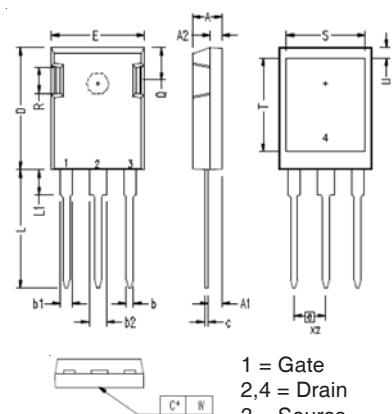
Symbol	Test Conditions (T _J = 25°C, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
g_{fs}	V _{DS} = -10V, I _D = -45A, Note 1	22	37	S
C_{iss}	V _{GS} = 0V, V _{DS} = -25V, f = 1MHz	5800	pF	
C_{oss}		1990	pF	
C_{rss}		510	pF	
$t_{d(on)}$	Resistive Switching Times V _{GS} = -10V, V _{DS} = 0.5 • V _{DSS} , I _D = -45A R _G = 3Ω (External)	25	ns	
t_r		77	ns	
$t_{d(off)}$		54	ns	
t_f		60	ns	
$Q_{g(on)}$	V _{GS} = -10V, V _{DS} = 0.5 • V _{DSS} , I _D = -45A	120	nC	
Q_{gs}		23	nC	
Q_{gd}		60	nC	
R _{thJC}			0.66 °C/W	
R _{thCS}		0.15	°C/W	

Source-Drain Diode

Symbol	Test Conditions (T _J = 25°C, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
I _s	V _{GS} = 0V			-90 A
I _{SM}	Repetitive, Pulse Width Limited by T _{JM}			-360 A
V _{SD}	I _F = -45A, V _{GS} = 0V, Note 1			-3.3 V
t_{rr}	I _F = -45A, -di/dt = -100A/μs V _R = -50V, V _{GS} = 0V	144	ns	
Q _{RM}		0.92	μC	
I _{RM}		-12.8	A	

Note

1: Pulse test, t ≤ 300μs, duty cycle, d ≤ 2%.

ISOPLUS247 (IXTR) Outline

SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.190	.205	4.83	5.21
A1	.090	.100	2.29	2.54
A2	.075	.085	1.91	2.16
b	.045	.055	1.14	1.40
b1	.075	.085	1.91	2.15
b2	.115	.126	2.92	3.20
C	.024	.033	0.61	0.83
D	.819	.840	20.80	21.34
E	.620	.635	15.75	16.13
e	.215 BSC		5.45 BSC	
L	.780	.801	19.81	20.60
L1	.150	.172	3.81	4.38
Q	.220	.244	5.59	6.20
R	.170	.191	4.32	4.85
S	.520	.540	13.21	13.72
T	.620	.640	15.75	16.26
U	.065	.080	1.65	2.03
W	0	.004	0	0.10

IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: 4,835,592 4,931,844 5,049,961 5,237,481 6,162,665 6,404,065 B1 6,683,344 6,727,585 7,005,734 B2 7,157,338B2 4,860,072 5,017,508 5,063,307 5,381,025 6,259,123 B1 6,534,343 6,710,405 B2 6,759,692 7,063,975 B2 4,881,106 5,034,796 5,187,117 5,486,715 6,306,728 B1 6,583,505 6,710,463 6,771,478 B2 7,071,537

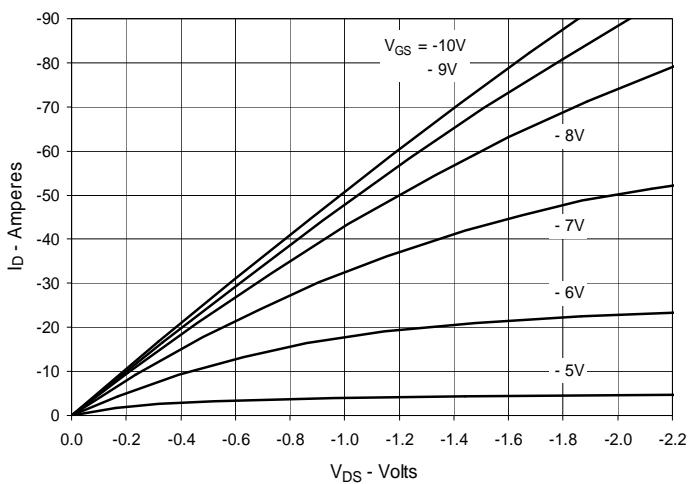
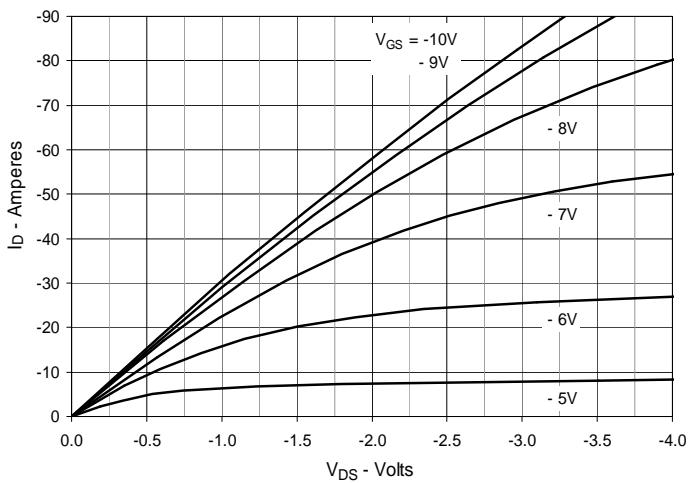
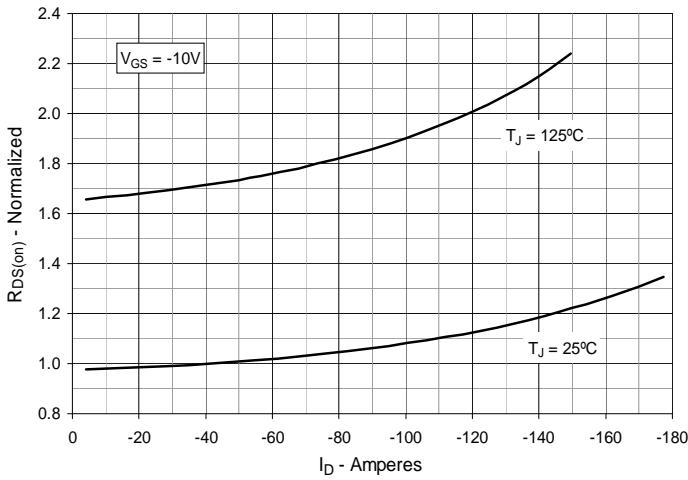
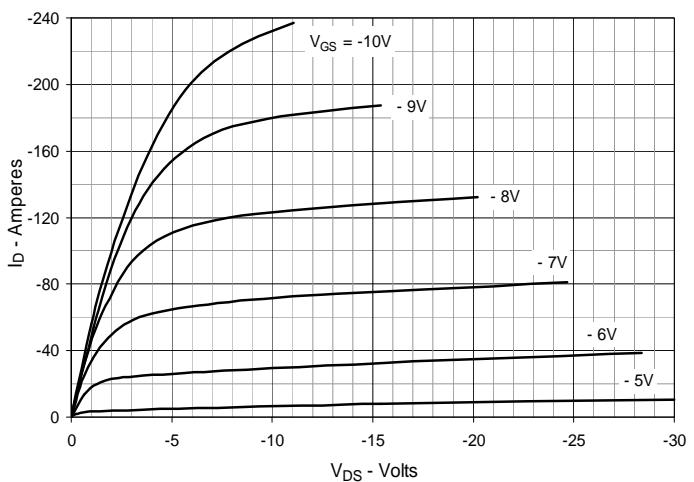
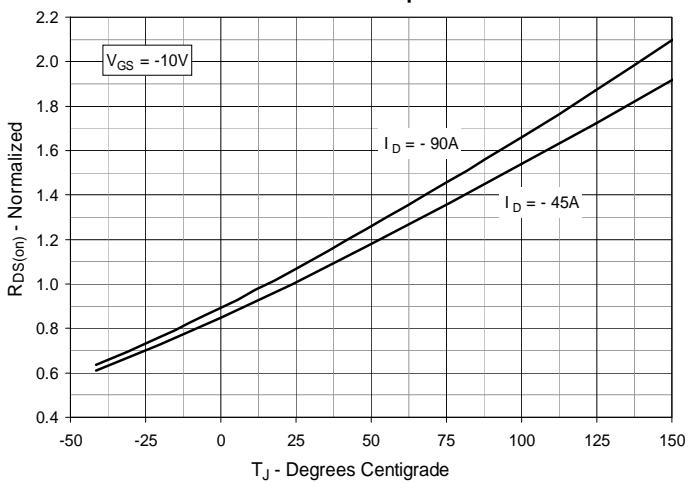
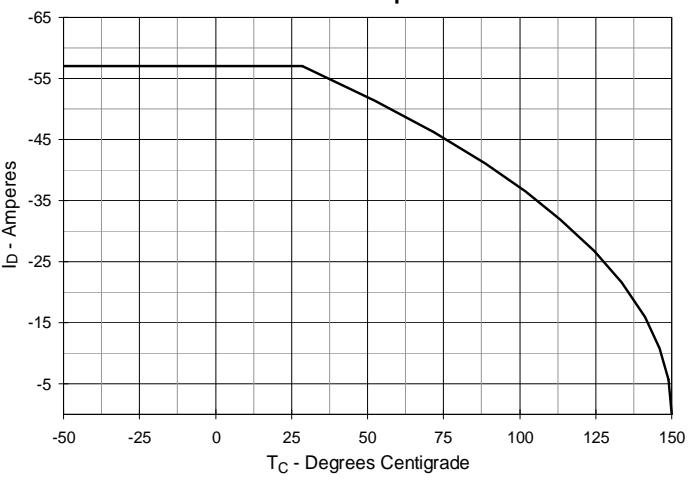
Fig. 1. Output Characteristics @ $T_J = 25^\circ\text{C}$ **Fig. 3. Output Characteristics @ $T_J = 125^\circ\text{C}$** **Fig. 5. $R_{DS(on)}$ Normalized to $I_D = -45\text{A}$ value vs. Drain Current****Fig. 2. Extended Output Characteristics @ $T_J = 25^\circ\text{C}$** **Fig. 4. $R_{DS(on)}$ Normalized to $I_D = -45\text{A}$ Value vs. Junction Temperature****Fig. 6. Maximum Drain Current vs. Case Temperature**

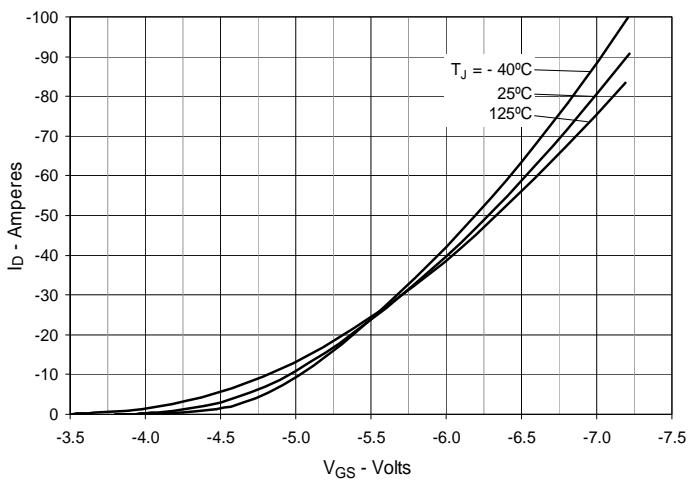
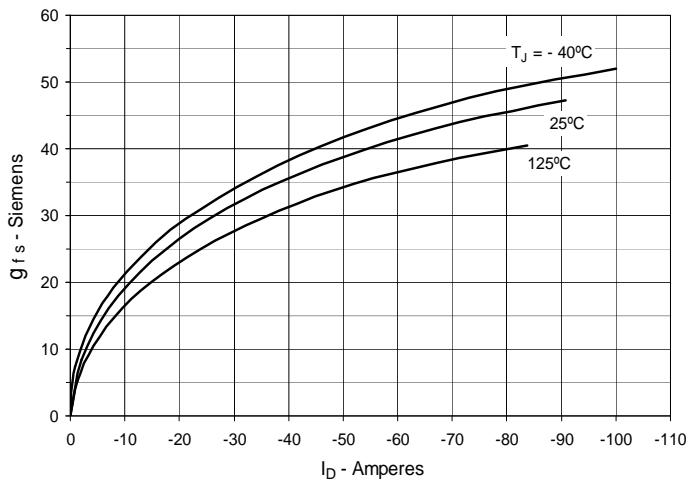
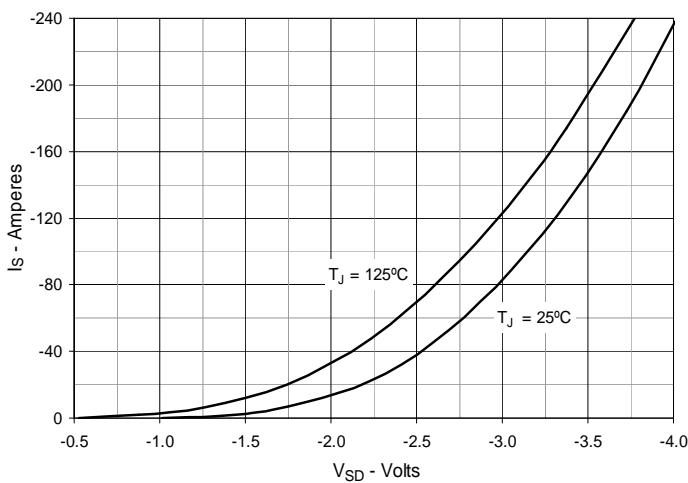
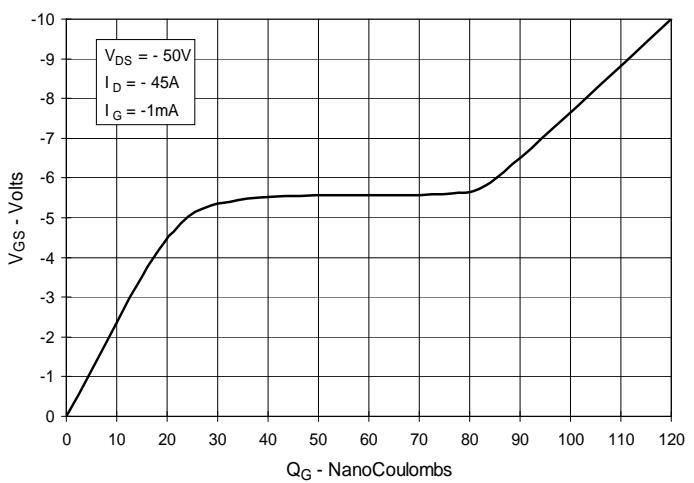
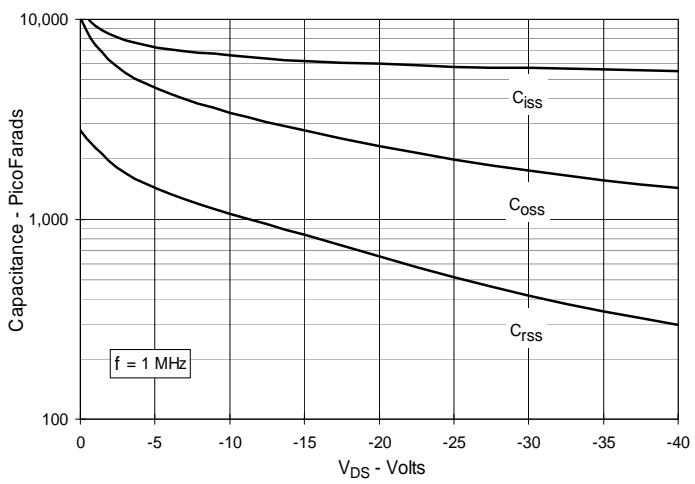
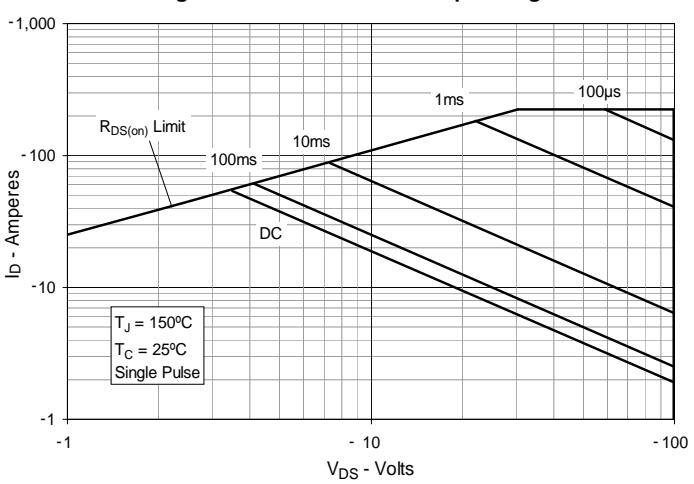
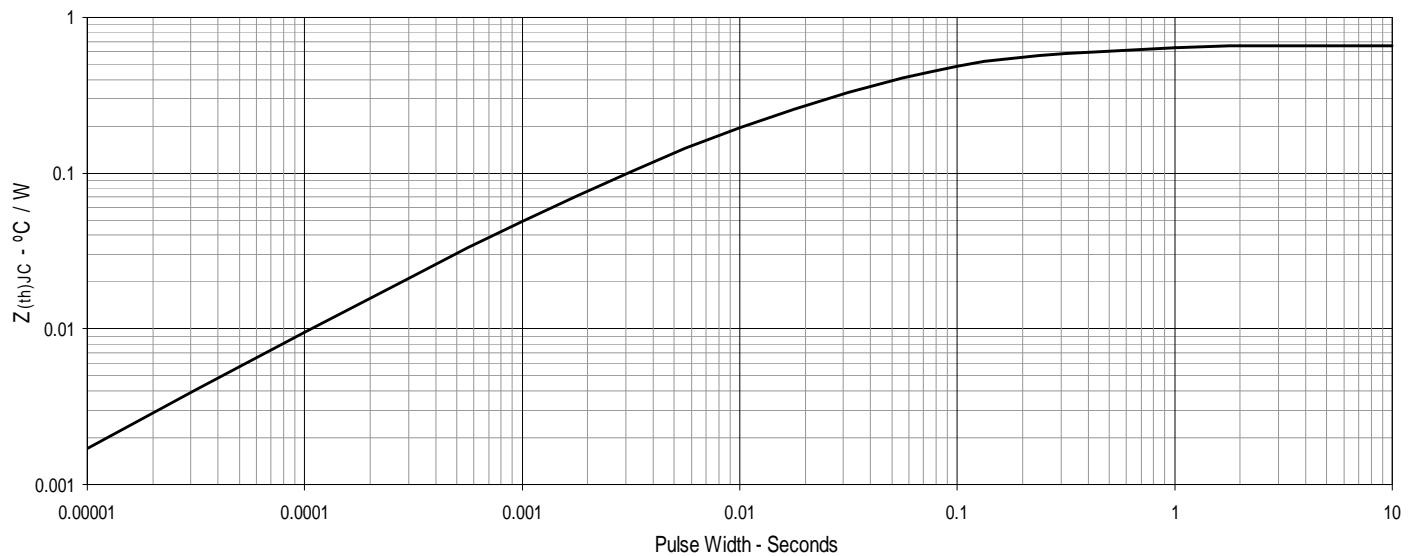
Fig. 7. Input Admittance**Fig. 8. Transconductance****Fig. 9. Forward Voltage Drop of Intrinsic Diode****Fig. 10. Gate Charge****Fig. 11. Capacitance****Fig. 12. Forward-Bias Safe Operating Area**

Fig. 13. Maximum Transient Thermal Impedance

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